Preferred Device

Power MOSFET 200 mA, 50 V

N–Channel SOT–23

Typical applications are DC–DC converters, power management in portable and battery–powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

Features

- Low Threshold Voltage (V_{GS(th)}: 0.5 V–1.5 V) Makes it Ideal for Low Voltage Applications
- Miniature SOT-23 Surface Mount Package Saves Board Space
- Pb–Free Packages are Available

| MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted) | | | | | | |
|--|-----------------------------------|-------------|------|--|--|--|
| Rating | Symbol | Value | Unit | | | |
| Drain-to-Source Voltage | V _{DSS} | 50 | Vdc | | | |
| Gate-to-Source Voltage - Continuous | V _{GS} | ± 20 | Vdc | | | |
| Drain Current – Continuous @ $T_A = 25^{\circ}C$ – Pulsed Drain Current ($t_p \le 10 \ \mu s$) | I _D I _{DM} | 200 800 | mA | | | |
| Total Power Dissipation @ $T_A = 25^{\circ}C$ | PD | 225 | mW | | | |
| Operating and Storage Temperature Range | T _J , T _{stg} | – 55 to 150 | °C | | | |
| Thermal Resistance, Junction–to–Ambient | R_{\thetaJA} | 556 | °C/W | | | |
| Maximum Lead Temperature for Soldering Purposes, for 10 seconds | ΤL | 260 | °C | | | |

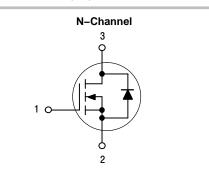
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

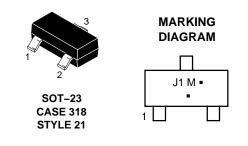


ON Semiconductor®

http://onsemi.com

200 mA, 50 V R_{DS(on)} = 3.5 Ω





J1 = Device Code

M = Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|------------|---------------------|-----------------------|
| BSS138LT1 | SOT-23 | 3000 Tape & Reel |
| BSS138LT1G | SOT-23 (Pb-Free) | 3000 Tape & Reel |
| BSS138LT3 | SOT-23 | 10,000 Tape & Reel |
| BSS138LT3G | SOT-23 (Pb-Free) | 10,000 Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

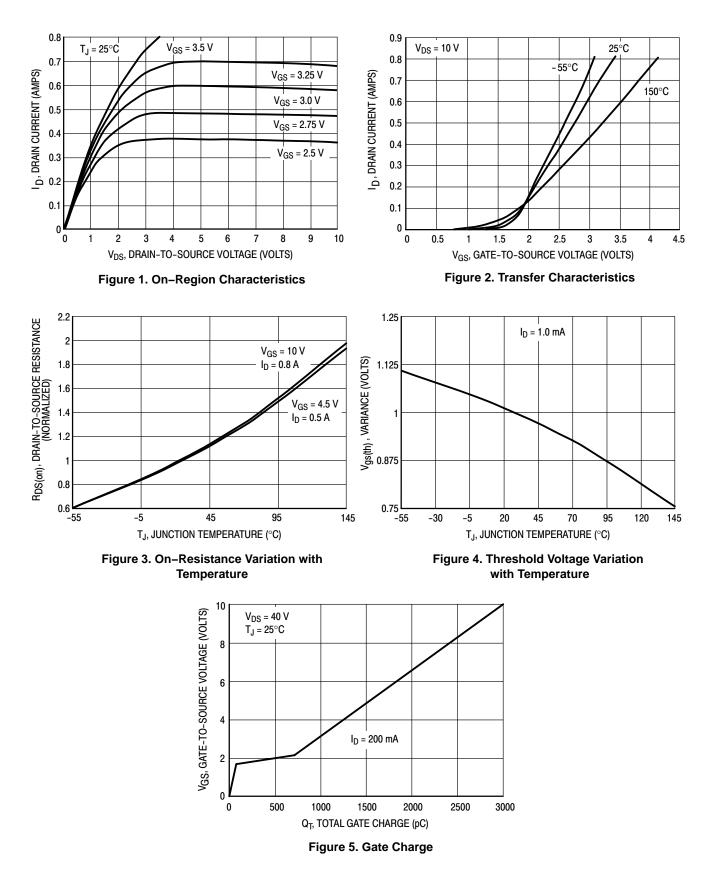
Preferred devices are recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

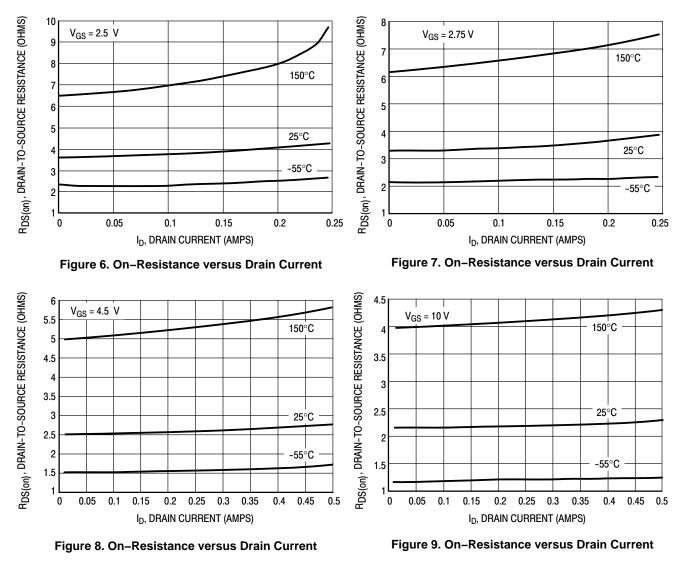
| Characteristic | | | Min | Тур | Max | Unit | |
|--|--|---------------------|-----|----------|------------|------|--|
| OFF CHARACTERISTICS | | | | | • | | |
| Drain–to–Source Breakdown Voltage $(V_{GS} = 0 \text{ Vdc}, I_D = 250 \ \mu\text{Adc})$ | | | 50 | - | - | Vdc | |
| Zero Gate Voltage Drain Current $(V_{DS} = 25 \text{ Vdc}, V_{GS} = 0 \text{ Vdc})$ $(V_{DS} = 50 \text{ Vdc}, V_{GS} = 0 \text{ Vdc})$ | | | | | 0.1 0.5 | μAdc | |
| Gate-Source Leakage Current (\ | I _{GSS} | - | - | ±0.1 | μAdc | | |
| ON CHARACTERISTICS (Note 1) | | · | | | | | |
| Gate–Source Threshold Voltage $(V_{DS} = V_{GS}, I_D = 1.0 \text{ mAdc})$ | V _{GS(th)} | 0.5 | _ | 1.5 | Vdc | | |
| Static Drain-to-Source On-Resistance ($V_{GS} = 2.75$ Vdc, $I_D < 200$ mAdc, $T_A = -40^{\circ}C$ to +85°C) ($V_{GS} = 5.0$ Vdc, $I_D = 200$ mAdc) | | r _{DS(on)} | | 5.6 - | 10 3.5 | Ω | |
| Forward Transconductance $(V_{DS} = 25 \text{ Vdc}, I_D = 200 \text{ mAdc},$ | 9 _{fs} | 100 | - | - | mmhos | | |
| DYNAMIC CHARACTERISTICS | | | | • | - | | |
| Input Capacitance | $(V_{DS} = 25 \text{ Vdc}, V_{GS} = 0, f = 1 \text{ MHz})$ | C _{iss} | - | 40 | 50 | pF | |
| Output Capacitance | (V _{DS} = 25 Vdc, V _{GS} = 0, f = 1 MHz) | C _{oss} | _ | 12 | 25 | 1 | |
| Transfer Capacitance | $(V_{DG} = 25 \text{ Vdc}, V_{GS} = 0, f = 1 \text{ MHz})$ | C _{rss} | - | 3.5 | 5.0 | 1 | |
| SWITCHING CHARACTERISTICS | (Note 2) | · | • | • | | • | |
| Turn-On Delay Time | $(1) = 20)(d_0 + 0.2)(d_0)$ | t _{d(on)} | - | - | 20 | ns | |
| Turn-Off Delay Time | $(V_{DD} = 30 \text{ Vdc}, I_D = 0.2 \text{ Adc},)$ | t _{d(off)} | _ | - | 20 | 1 | |

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
Switching characteristics are independent of operating junction temperature.

TYPICAL ELECTRICAL CHARACTERISTICS



TYPICAL ELECTRICAL CHARACTERISTICS



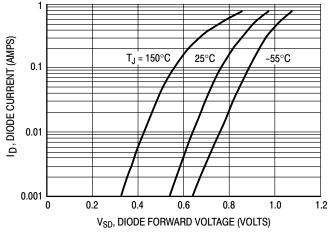


Figure 10. Body Diode Forward Voltage

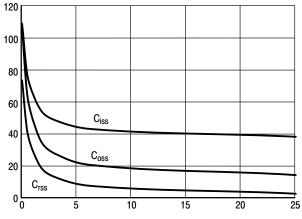
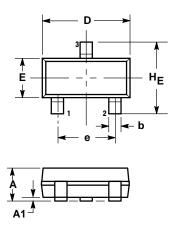
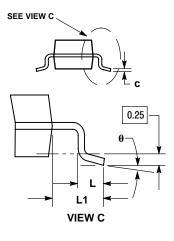


Figure 11. Capacitance

PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 ISSUE AN





NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

 CONTROLLING DIMENSION: INCH.
MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF

THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL. 4 318-01 THRU -07 AND -09 OBSOLETE

4. 318–01 THRU –07 AND –09 OBSOLETE, NEW STANDARD 318–08.

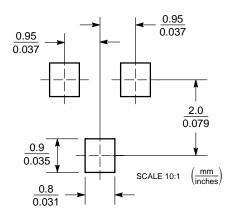
| | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|-------|-------|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX |
| Α | 0.89 | 1.00 | 1.11 | 0.035 | 0.040 | 0.044 |
| A1 | 0.01 | 0.06 | 0.10 | 0.001 | 0.002 | 0.004 |
| b | 0.37 | 0.44 | 0.50 | 0.015 | 0.018 | 0.020 |
| С | 0.09 | 0.13 | 0.18 | 0.003 | 0.005 | 0.007 |
| D | 2.80 | 2.90 | 3.04 | 0.110 | 0.114 | 0.120 |
| E | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| е | 1.78 | 1.90 | 2.04 | 0.070 | 0.075 | 0.081 |
| L | 0.10 | 0.20 | 0.30 | 0.004 | 0.008 | 0.012 |
| L1 | 0.35 | 0.54 | 0.69 | 0.014 | 0.021 | 0.029 |
| HE | 2.10 | 2.40 | 2.64 | 0.083 | 0.094 | 0.104 |

STYLE 21:

PIN 1. GATE 2. SOURCE

3. DRAIN

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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